

#### **OSRW1615C1C**

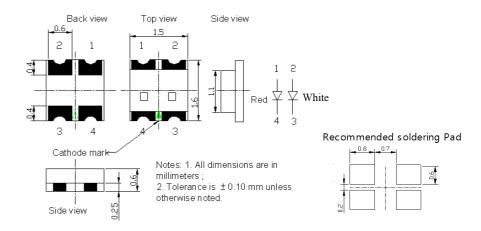
#### **■Features**

- · Bi-Color
- Super high brightness of surface mount LED
- Yellow Diffused Lens
- Compact package outline (LxWxT) of 1.6mm x 1.5mm x 0.6mm
- Compatible to Reflow soldering.

### **■**Applications

• Backlighting (switches, keys, etc.) Marker lights (e.g. steps, exit ways, etc.)

#### **■Outline Dimension**



#### ■Absolute Maximum Rating

# (Ta=25°C)

Item	Symbol	Va	Unit	
		Red	White	Oillt
DC Forward Current	$I_F$	25	25	mA
Pulse Forward Current#	$I_{\mathrm{FP}}$	100	100	mA
Reverse Voltage	$V_R$	5	5	V
Power Dissipation	$P_{D}$	60	85	mW
Operating Temperature	Topr	-40 ~ +85		$^{\circ}\!\mathbb{C}$
Storage Temperature	Tstg	-40~ +85		$^{\circ}\!\mathbb{C}$
Lead Soldering Temperature	Tsol	260°C/10sec		=

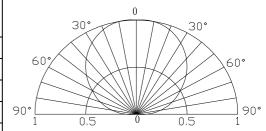
#Pulse width Max 0.1ms, Duty ratio max 1/10 **■Electrical -Optical Characteristics** 

# (Ta=25℃)

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
DC Forward Voltage*1	$V_F(Red)$	I <sub>F</sub> =5mA	-	1.8	2.4	V
	V <sub>F</sub> ( White)	I <sub>F</sub> =5mA	-	2.8	3.4	V
DC Reverse Current	$I_R$	V <sub>R</sub> =5V	-	1	10	μA
Domi. Wavelength*2	$\lambda_D(Red)$	I <sub>F</sub> =5mA	620	625	630	nm
Color Temperature*3	CCT( White)	I <sub>F</sub> =5mA	8000	12000	18000	K
Luminous Intensity*4	Iv(Red)	I <sub>F</sub> =5mA	20	30	-	mcd
	Iv(White)	I <sub>F</sub> =5mA	100	150	i	mcd
50% Power Angle	201/2	I <sub>F</sub> =5mA	-	120	-	deg

<sup>\*1</sup> Tolerance of measurements of forward voltage is  $\pm 0.1$ V

# Directivity











<sup>\*2</sup> Tolerance of measurements of dominant wavelength is ±1nm

<sup>\*3</sup> Tolerance of measurements of color temperature ±10%

<sup>\*4</sup> Tolerance of measurements of luminous intensity is +15%

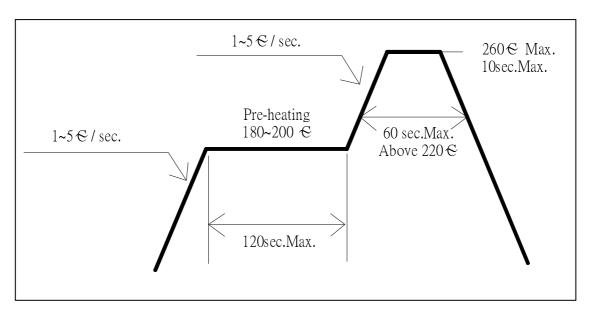


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#### **■** Soldering Conditions

Reflow Soldering		Hand Soldering			
Pre-Heat	180 ~ 200°C				
Pre-Heat Time	120 sec. Max.				
Peak temperature	260°C Max.	Temperature	350°C Max.		
Dipping Time	10 sec. Max.	Soldering time	3 sec. Max.		
Condition	Refer to Temperature-profile		(one time only)		

#### • Reflow Soldering Condition(Lead-free Solder)



- \*Recommended soldering conditions vary according to the type of LED
- \*Although the recommended soldering conditions are specified in the above table, reflow, or hand soldering at the lowest possible temperature is desirable for the LEDs.
- \*A rapid-rate process is not recommended for cooling the LEDs down from the peak temperature.
- •All SMD LED products are pb-free soldering available.
- Occasionally there is a brightness decrease caused by the influence of heat or ambient atmosphere during air reflow. It is recommended that the User use the nitrogen reflow method.
- Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable a double-head soldering iron should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.
- Reflow soldering should not be done more than two times.
- When soldering, do not put stress on the LEDs during heating.
- After soldering, do not warp the circuit board.





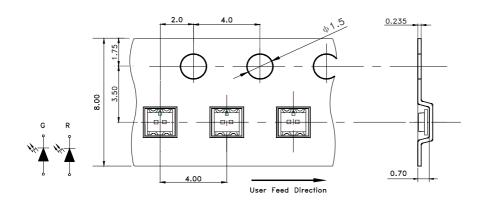




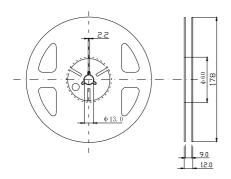


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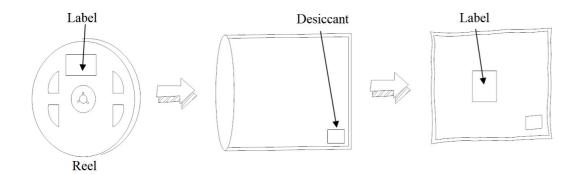
#### ■ Reel & Tape Dimensions (4000pcs/reel):



#### **■Reel Dimensions:**



#### ■ Moisture Resistant Packaging:













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#### **■** Cautions:

- 1. After open the package, the LED's floor life is 4 Weeks under 30℃ or less and 60%RH or less(MSL:2a).
- 2. Heat generation must be taken into design consideration when using the LED.
- 3. Power must be applied resistors for protection, over current would be caused the optic damage to the devices and wavelength shift.
- 4. Manual tip solder may cause the damage to Chip devices, so advised that heat of iron should be lower than 15W with temperature control under 5 seconds at 230-260 deg. C. (The device would be got damage in re working process, recommended under 5 seconds at 230-260 deg. C)
- 5. All equipment and machinery must be properly grounded. It is recommended to use a wristband or anti-electrostatic glove when handing the LED.
- 6. Use IPA as a solvent for cleaning the LED. The other solvent may dissolve the LED package and the epoxy, Ultrasonic cleaning should not be done.
- 7. Damaged LED will show unusual characteristics such as leak current remarkably increase, turn-on voltage becomes lower and the LED get unlight at low current.









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